

MOSFET

OptiMOS[™] 5 Power-Transistor, 30 V

Features

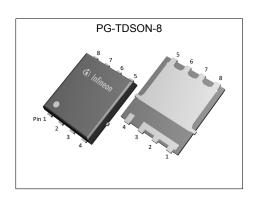
- Very low on-resistance $R_{\rm DS(on)}$ @ $V_{\rm GS}$ =4.5 V Optimized charges for fast switching Optimized QGD/QGS for induced turn on ruggedness Superior thermal resistance
- N-channel
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

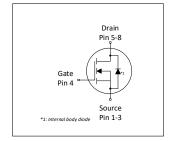
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Roy 1 of formation 1 aramotore							
Parameter	Value	Unit					
V _{DS}	30	V					
R _{DS(on),max}	0.55	mΩ					
I _D	433	A					
Qoss	70	nC					
Q _G (0V4.5V)	59	nC					











Type / Ordering Code	Package	Marking	Related Links
BSC005N03LS5	PG-TDSON-8 FL	05N03LS5	-

OptiMOSTM 5 Power-Transistor, 30 V BSC005N03LS5



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OptiMOS[™] 5 Power-Transistor, 30 V BSC005N03LS5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Damana dan	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	-	433 306 42	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =50 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1731	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	900	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	188 3.0	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Downwotor	Cumbal	Values			l lmi4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	0.8	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Device on PCB, 6 cm² cooling area	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™] 5 Power-Transistor, 30 V BSC005N03LS5



Electrical characteristics

at T_j=25 °C, unless otherwise specified

Static characteristics Table 4

Parameter.	Oh l		Values			N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	30	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.0	1.5	2.0	V	V _{DS} =V _{GS} , I _D =250 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μΑ	V _{DS} =30 V, V _{GS} =0 V, T _j =25 °C V _{DS} =30 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.48 0.63	0.55 0.95	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =4.5 V, I _D =50 A
Gate resistance ¹⁾	R _G	-	0.7	1.2	Ω	-
Transconductance	g fs	-	300	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 50 A$

Table 5 **Dynamic characteristics**

Parameter	Cumbal	Values			l lmit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C _{iss}	-	8900	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Output capacitance	Coss	-	2700	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Reverse transfer capacitance	C _{rss}	-	300	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	21	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	20.7	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	48.4	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	16.2	_	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Cumbal	Values			l lmi4	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	21	-	nC	V_{DD} =15 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	12	-	nC	V_{DD} =15 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate to drain charge	Q _{gd}	-	14	-	nC	V _{DD} =15 V, I _D =50 A, V _{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	22	-	nC	V _{DD} =15 V, I _D =50 A, V _{GS} =0 to 4.5 V
Gate charge total	Qg	-	59	-	nC	V _{DD} =15 V, I _D =50 A, V _{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.3	-	V	V _{DD} =15 V, I _D =50 A, V _{GS} =0 to 4.5 V
Gate charge total	Qg	-	122	-	nC	V _{DD} =15 V, I _D =50 A, V _{GS} =0 to 10 V
Output charge	Qoss	-	70	-	nC	V _{DS} =15 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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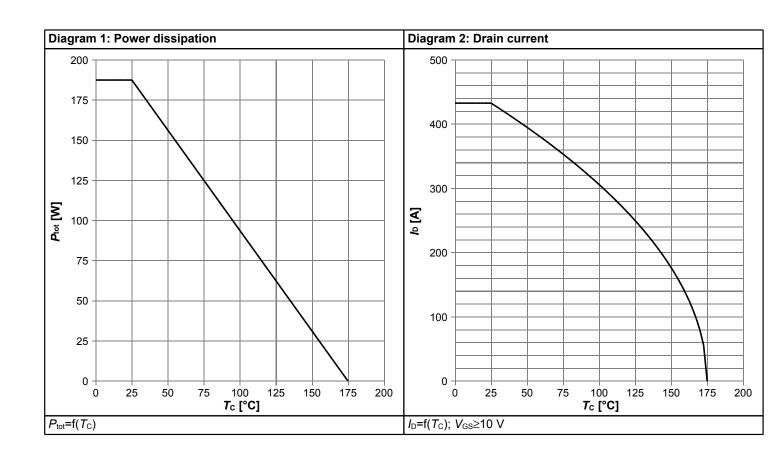


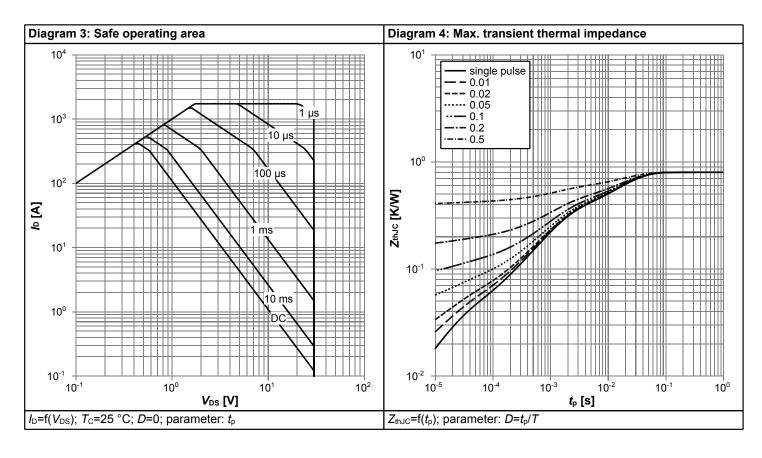
Table 7 Reverse diode

Doromotor	Symbol		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	188	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1731	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.79	1	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C	
Reverse recovery charge	Qrr	-	30	-	nC	V _R =15 V, I _F =I _S , di _F /dt=400 A/μs	

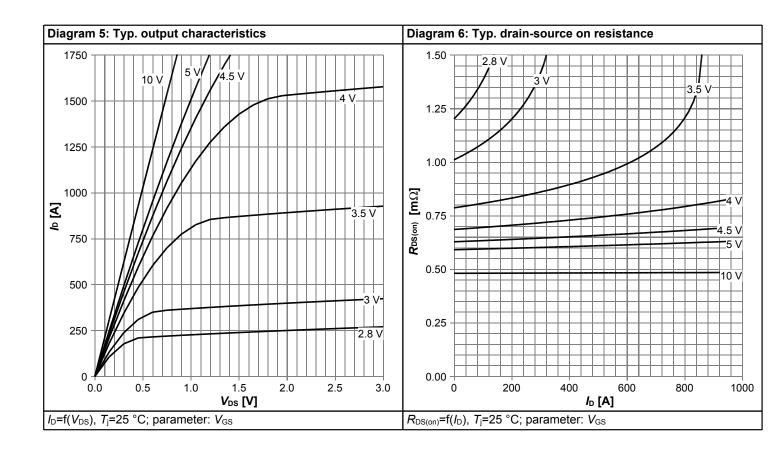


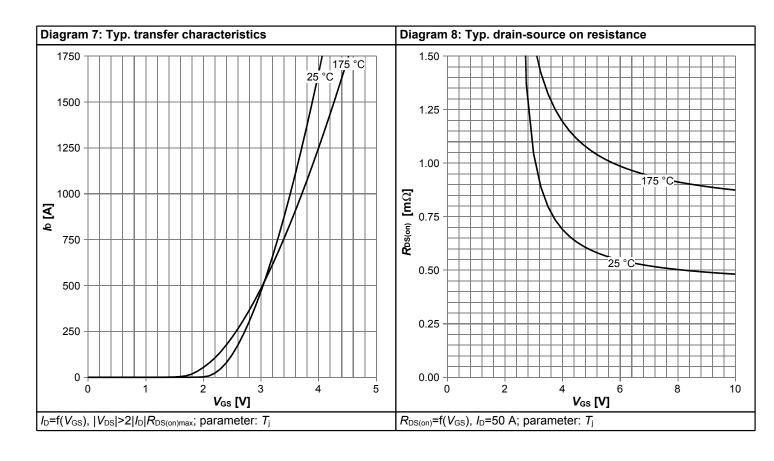
4 Electrical characteristics diagrams



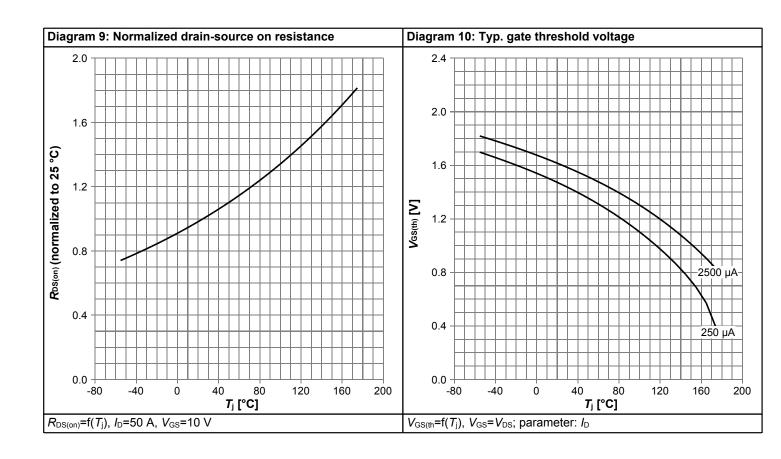


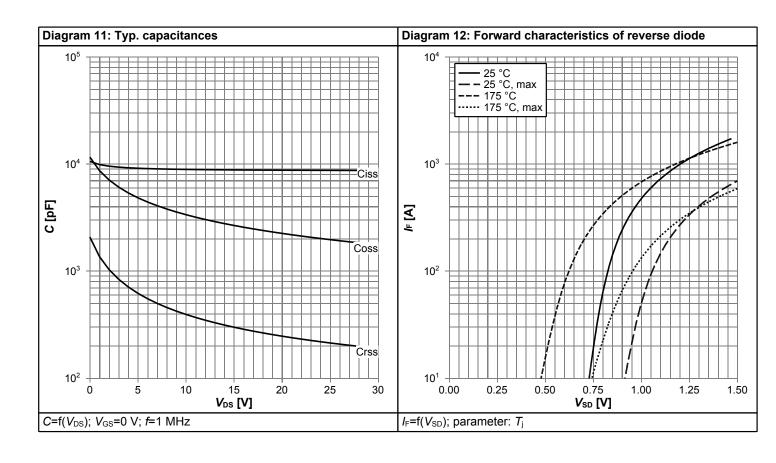




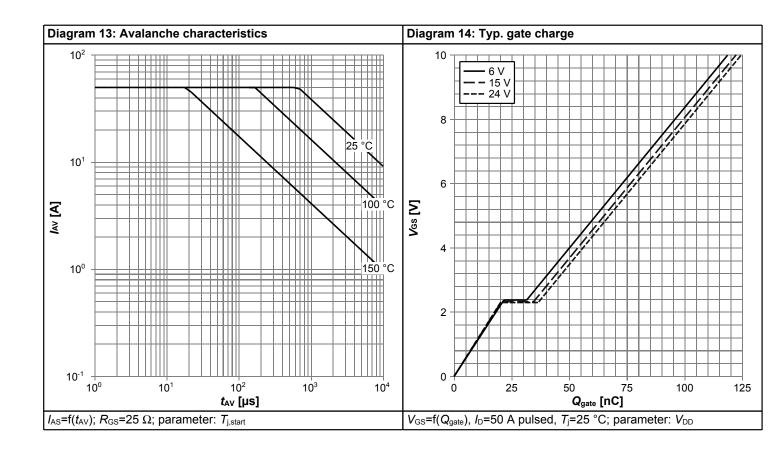


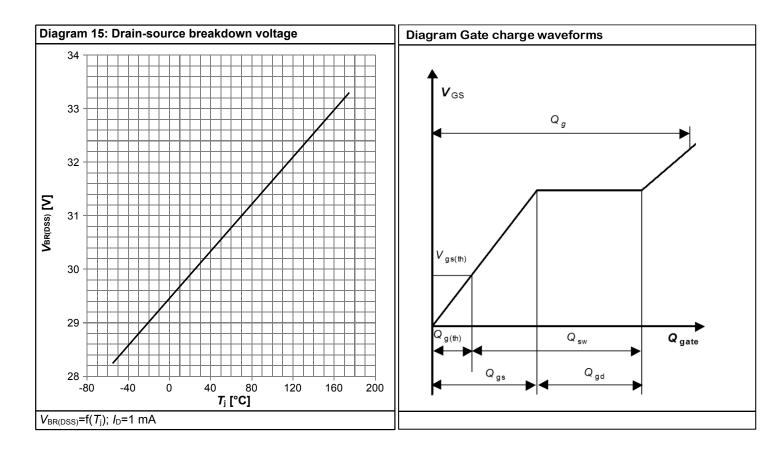














5 Package Outlines

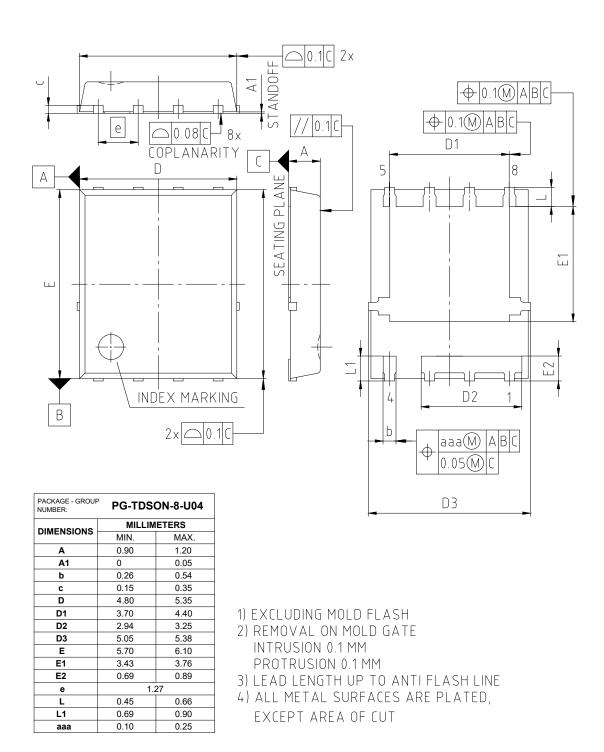


Figure 1 Outline PG-TDSON-8 FL, dimensions in mm



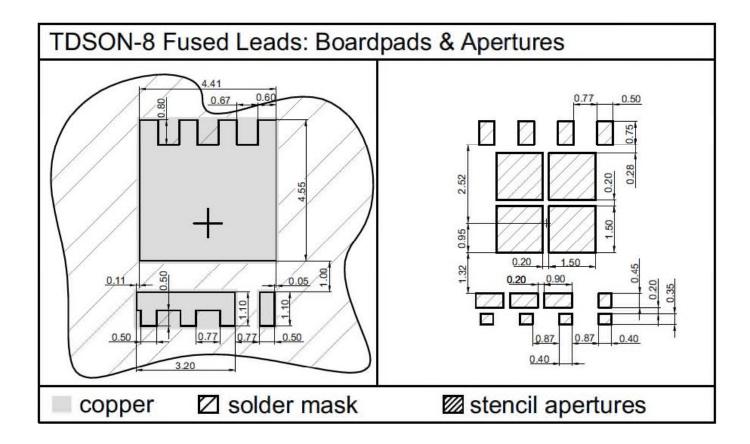


Figure 2 Outline Boardpads (TDSON-8 FL)

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Revision History

BSC005N03LS5

Revision: 2022-10-24, Rev. 2.2

Previous	Dovicion
Previous	Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2020-04-16	Release of final version				
2.1	2020-12-22	Update Id for VGSTH				
2.2	2022-10-24	Update outline drawing				

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